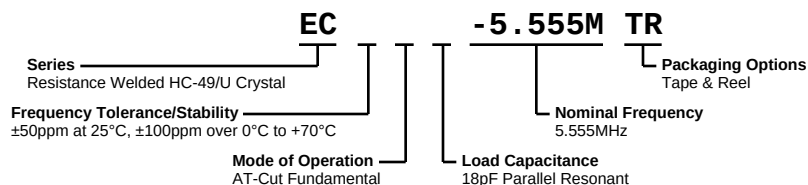


# EC-5.555M TR



## ELECTRICAL SPECIFICATIONS

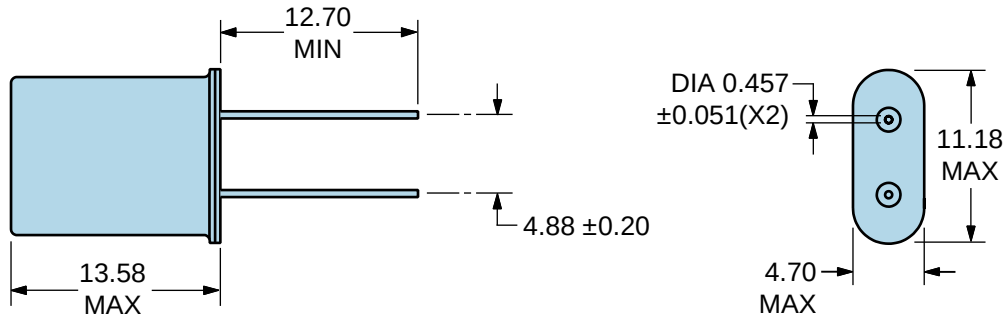
|                               |                                                                                                              |
|-------------------------------|--------------------------------------------------------------------------------------------------------------|
| Nominal Frequency             | 5.555MHz                                                                                                     |
| Frequency Tolerance/Stability | $\pm 50\text{ppm}$ at $25^\circ\text{C}$ , $\pm 100\text{ppm}$ over $0^\circ\text{C}$ to $+70^\circ\text{C}$ |
| Aging at $25^\circ\text{C}$   | $\pm 5\text{ppm/year}$ Maximum                                                                               |
| Load Capacitance              | 18pF Parallel Resonant                                                                                       |
| Shunt Capacitance (C0)        | 7pF Maximum                                                                                                  |
| Equivalent Series Resistance  | 75 Ohms Maximum                                                                                              |
| Mode of Operation             | AT-Cut Fundamental                                                                                           |
| Drive Level                   | 2mWatts Maximum                                                                                              |
| Storage Temperature Range     | $-40^\circ\text{C}$ to $+85^\circ\text{C}$                                                                   |
| Insulation Resistance         | 500 Megaohms Minimum at 100Vdc                                                                               |

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |                                       |
|------------------------------|---------------------------------------|
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C |
| Lead Integrity               | MIL-STD-883, Method 2004              |
| Mechanical Shock             | MIL-STD-202, Method 213, Condition C  |
| Resistance to Soldering Heat | MIL-STD-202, Method 210               |
| Resistance to Solvents       | MIL-STD-202, Method 215               |
| Solderability                | MIL-STD-883, Method 2003              |
| Temperature Cycling          | MIL-STD-883, Method 1010              |
| Vibration                    | MIL-STD-883, Method 2007, Condition A |

# EC-5.555M TR

MECHANICAL DIMENSIONS (all dimensions in millimeters)

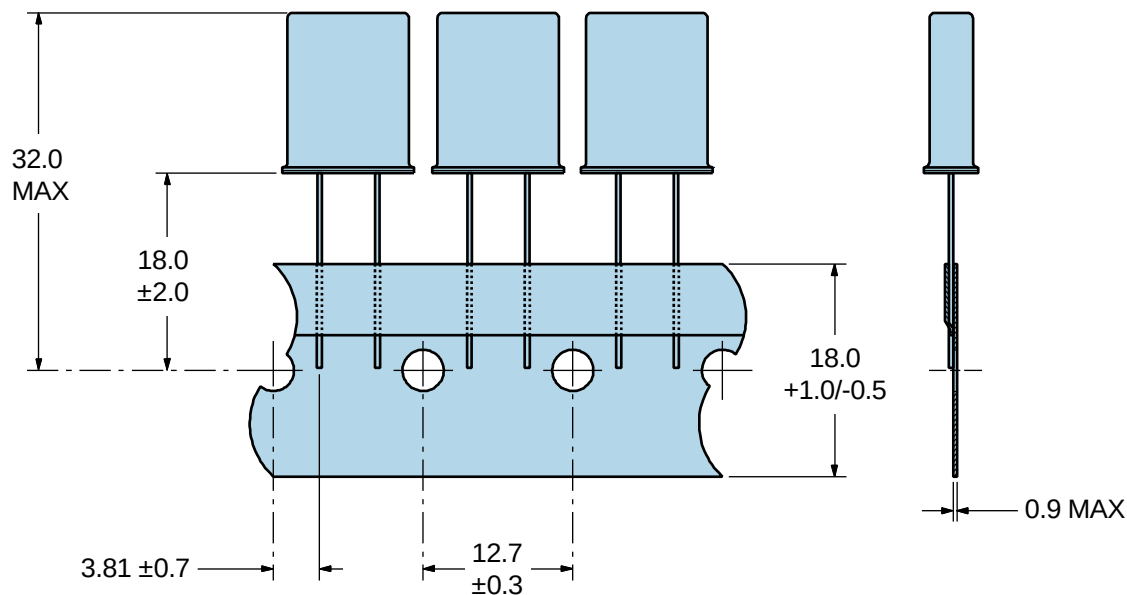


| LINE | MARKING                                                              |
|------|----------------------------------------------------------------------|
| 1    | <b>ECLIPTEK</b>                                                      |
| 2    | <b>E5.555M</b><br><i>E=Ecliptek Designator or Blank (No Marking)</i> |
| 3    | <b>XX</b><br><i>XX=Ecliptek Manufacturing Code</i>                   |

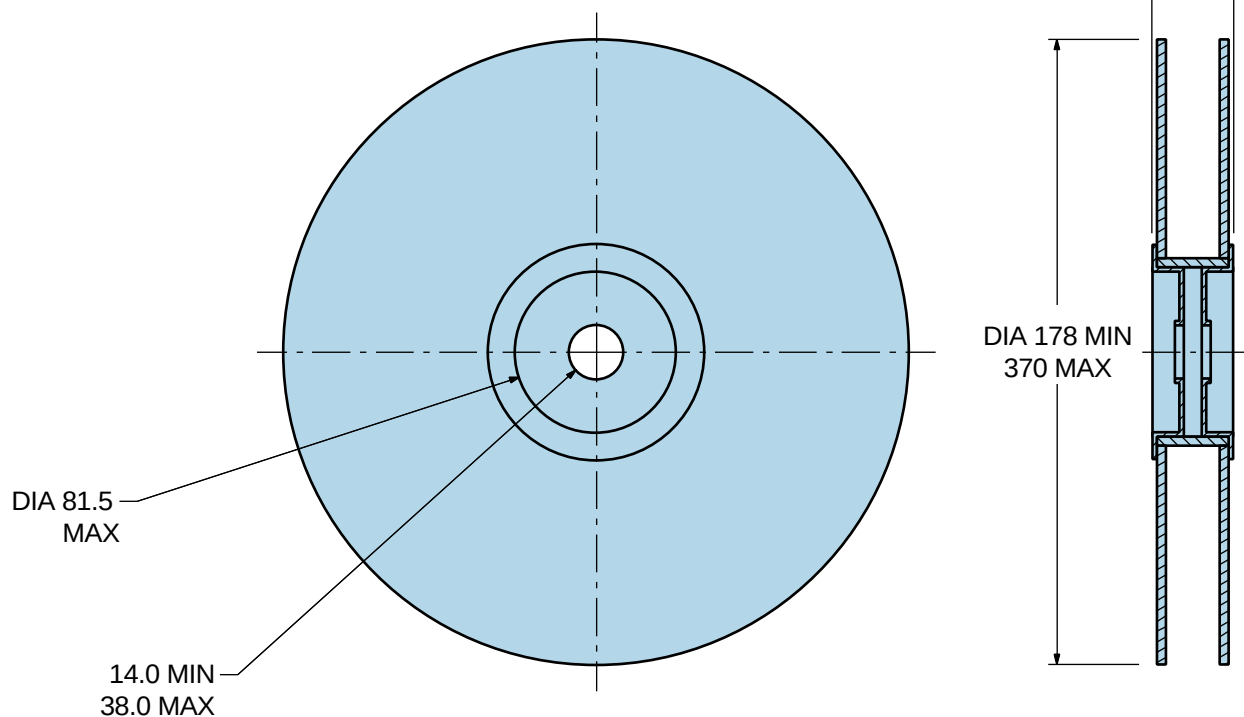
# EC-5.555M TR

## Tape & Reel Dimensions

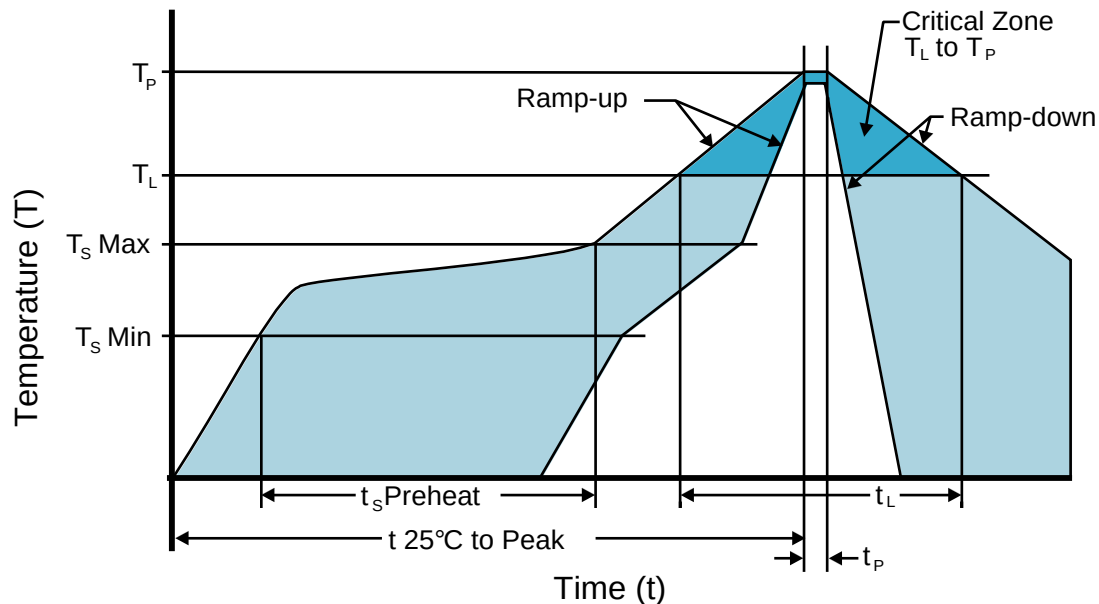
Quantity Per Reel: 1,000 Pieces



\*Compliant to EIA 468B



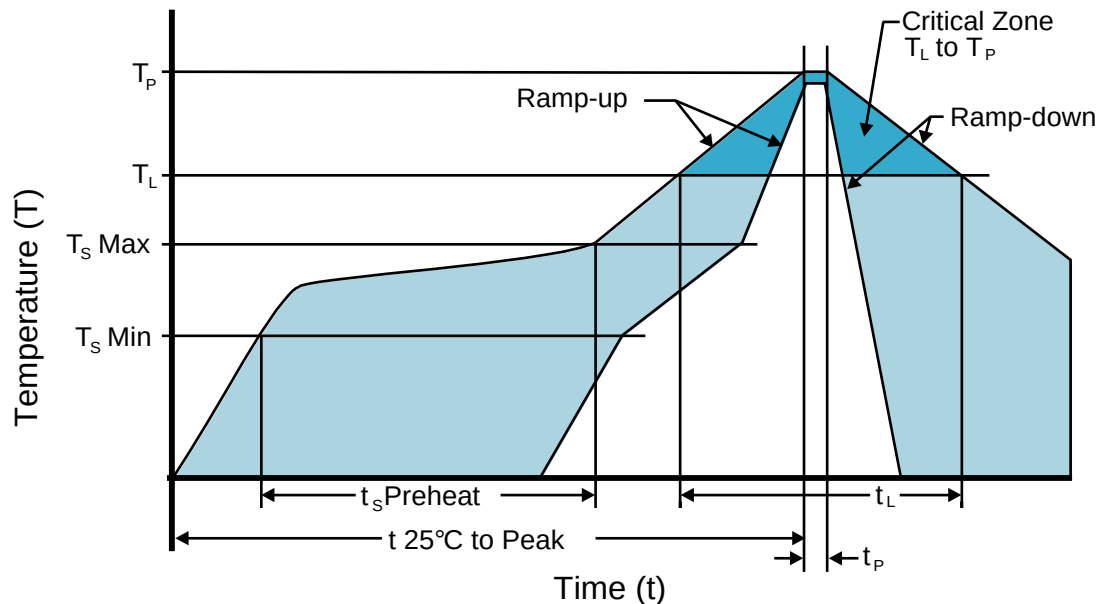
## Recommended Solder Reflow Methods



### High Temperature Solder Bath (Wave Solder)

|                                                                |                                      |
|----------------------------------------------------------------|--------------------------------------|
| <b><math>T_S</math> MAX to <math>T_L</math> (Ramp-up Rate)</b> | 3°C/second Maximum                   |
| <b>Preheat</b>                                                 |                                      |
| - Temperature Minimum ( $T_S$ MIN)                             | 150°C                                |
| - Temperature Typical ( $T_S$ TYP)                             | 175°C                                |
| - Temperature Maximum ( $T_S$ MAX)                             | 200°C                                |
| - Time ( $t_s$ MIN)                                            | 60 - 180 Seconds                     |
| <b>Ramp-up Rate (<math>T_L</math> to <math>T_P</math>)</b>     | 3°C/second Maximum                   |
| <b>Time Maintained Above:</b>                                  |                                      |
| - Temperature ( $T_L$ )                                        | 217°C                                |
| - Time ( $t_L$ )                                               | 60 - 150 Seconds                     |
| <b>Peak Temperature (<math>T_P</math>)</b>                     | 260°C Maximum for 10 Seconds Maximum |
| <b>Target Peak Temperature (<math>T_P</math> Target)</b>       | 250°C +0/-5°C                        |
| <b>Time within 5°C of actual peak (<math>t_P</math>)</b>       | 20 - 40 seconds                      |
| <b>Ramp-down Rate</b>                                          | 6°C/second Maximum                   |
| <b>Time 25°C to Peak Temperature (<math>t</math>)</b>          | 8 minutes Maximum                    |
| <b>Moisture Sensitivity Level</b>                              | Level 1                              |

## Recommended Solder Reflow Methods



### Low Temperature Solder Bath (Wave Solder)

**T<sub>S</sub> MAX to T<sub>L</sub> (Ramp-up Rate)** 5°C/second Maximum

#### Preheat

- Temperature Minimum (T<sub>S</sub> MIN) N/A  
 - Temperature Typical (T<sub>S</sub> TYP) 150°C  
 - Temperature Maximum (T<sub>S</sub> MAX) N/A  
 - Time (t<sub>s</sub> MIN) 30 - 60 Seconds

**Ramp-up Rate (T<sub>L</sub> to T<sub>P</sub>)** 5°C/second Maximum

#### Time Maintained Above:

- Temperature (T<sub>L</sub>) 150°C  
 - Time (t<sub>L</sub>) 200 Seconds Maximum

**Peak Temperature (T<sub>P</sub>)** 245°C Maximum

**Target Peak Temperature (T<sub>P</sub> Target)** 245°C Maximum 1 Time / 235°C Maximum 2 Times

**Time within 5°C of actual peak (t<sub>p</sub>)** 5 seconds Maximum 1 Time / 15 seconds Maximum 2 Times

**Ramp-down Rate** 5°C/second Maximum

**Time 25°C to Peak Temperature (t)** N/A

**Moisture Sensitivity Level** Level 1

### Low Temperature Manual Soldering

185°C Maximum for 10 seconds Maximum, 2 times Maximum.

### High Temperature Manual Soldering

260°C Maximum for 5 seconds Maximum, 2 times Maximum.